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(54) Title: PARTICULATE WATER-ABSORBENT RESIN COMPOSITION AND ITS PRODUCTION PROCESS

(57) Abstract: An object of the present invention is to provide a particulate water-absorbent resin composition and its produc-
tion process, wherein the particulate water-absorbent resin composition is an enhanced one in both of the "liquid permeability" and
"liquid-sucking-up property" (which have hitherto been antithetical physical properties) of the water-absorbent resin. As a means
of achieving this object, a first particulate water-absorbent resin composition according to the present invention is a particulate
water-absorbent resin composition comprising a water-absorbent resin (A) of a crosslinked structure obtained by polymerizing an
acid-group-containing unsaturated monomer, with the composition being characterized by: having a particle size such that particles
in the range of 850 to 150 ƒÊm (but not including 850 ƒÊm) account for not less than 90 weight % of the entirety; and
containing a tetra- or more functional polyol (B) at least on surfaces.

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